

| MAIN PROCESS & SPECIFICATIONS | PROCESSING METHODS | PROCESS CAPABILITY | CAAS & FAA CERTIFIED | NADCAP ACCREDITED | ON SITE |
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Fluorescent Penetrant Inspection (FPI)

ASTM E1417, SPOP 62, SPOP 82, HS 447, PN 16.03, FEIS 701B, 981-060-021

Penetrant Type:
Type I – Fluorescent Penetrant (In accordance with QPL-AMS 2644)

Penetrant Removal Methods:
Method A
Water Washable

Method C
Solvent Removable

Method D
Hydrophilic
Post-Emulsified

Penetrant Sensitivity and Method by Spray Application:
Level 2 – Method A & D
Level 3 – Method A & D
Level 4 – Method D

Developer:
Form a – Dry Powder (Dust Storm Application)
Form d – Non-aqueous Wet Developer (Solvent Based)

Oven, Emulsifier and Developer Tank
Dimensions:
Depth: 800 mm,
Length: 1600 mm,
Width: 680 mm

Hoist for heavy parts up to 500kg

✓ ✓ ✓

Magnetic Particle Inspection (MPI)

ASTM E1444, SPOP 102, SPOP 105, HS 31, PN 16.04, FEIS 701A, 981-060-021

Magnetization Methods:
- Direct contact,
- Indirect magnetization,
- Induced current magnetization (Toroidal)

MPI machines (Magnaflux)
3 Phase Full Wave DC, 25 inch coil, 6000 Amp

Processing Capability:
Max part length: 1340 mm
Max part diameter: 630 mm

Yoke (AC & DC)
Fluorescent Magnetic Ink

✓ ✓ ✓

Eddy Current Testing (ET)

ASTM E376, ASTM E1004

High Frequency Eddy Current Testing,
Low Frequency Eddy Current Testing,
Conductivity Testing,
Flaw Detection

Nortec 500S

✓ ✓

Ultrasonic Testing (UT)

ASTM E114, ASTM E797/797M

Contact Testing,
Thickness Gauging,
Flaw Detection

Epoch 600

✓ ✓